RF Components Description Features	RMLA356 Wideband The Raytheon RF Comdesigned for the 3.5 - 6 external gate bias supprocess to provide low matched • 18.0 dB Gain typica • 12 dB Noise Figure • Single Positive Bias • Small Outline Metal • Internal 50 Ω Matched	5A-58 Low No bponents RMLA38 5.5 GHz frequency ply. This device of noise, high linearit s Typical 5.0 -6.5 C Base Quad Plast	ise MM 565A-58 is a sin 7 range. The M Ises Raytheon F 9, and low currer	C Amplifi PR gle bias wideband I MIC requires no ext RF Components' ad nt.	er ODUCT INF ow noise Mi ernal matchin vanced 0.25	ORMATION VIC amplifier ng circuits or µm PHEMT
Absolute Ratings	Parameter Positive Dra RF Input Po Drain Curren Case Opera Storage Ten Soldering Te Thermal Re (Channel	in DC Voltage wer (from 50Ω sour nt ting Temperature nperature Range emperature sistance I to Case)	Symbol V _{dd} Ce) P _{IN} (CW) I _{dd} T _{case} T _{storage} T _{solder} R _{jc}	Value 6.5 0 130 -35 to 85 -40 to 110 220 8	Unit V dBm mA °C °C °C °C	
Electrical Characteristics (50Ω System, V _{dd} = 4 V, T = +25°C)	Parameter Frequency Range Gain (Small Signal) ^{1,2} Gain Variation vs Temp Noise Figure ² 3.5 - 5 GHz 5 - 6.5 GHz 5 - 6.5 GHz 1. Pin = - 20, V _d = 4.0 V, Fred 2. Data de-embedded from fit	Min Typ M 3.5 6 17.0 18.0 0.013 1 1.7 1 1.3 1	axUnit.5GHzdBdB/°CdB/°C.4dB	ameter I er Out, P-1dB @ 5.5GHz,-8dBm Pour t/Output Return Loss	Min Typ 8.0 9.0 t 21.0 70 3.0 4.0 10.0	Max Unit dBm dBm 90 mA 6.0 V 5.0 dB
www.raytheonrf.com	Specifications are based o	n most current or lat	est revision.		Raytheon F	RF Components

Raytheon RF Components	RMLA3565A-58 Wideband Low Noise MMIC Amplifier PRODUCT INFORMATION				
Application Information	 CAUTION: THIS IS AN ESD SENSITIVE DEVICE The following briefly describes a procedure for evaluating the high efficiency PHEMT amplifier packaged in a surface mount package. It may be noted that the chip is a fully monolithic single ended two stage amplifier for 3.5 to 6.5 GHz applications. Figure 1 shows the functional block diagram of the packaged product. Test Fixture Figure 2 shows the outline and pin-out descriptions for the packaged device. A typical test fixture schematic showing external bias components is shown in Figure 3. Figure 4 shows typical layout of an evaluation board corresponding to the schematic diagram. Typical performance of the test fixture is shown in the performance data section. The following should be noted: (1) Package pin designations are shown in figure 2. (2) Vd is the drain voltage (positive) applied at the pins of the package. (3) Vdd is the positive supply voltage at the evaluation board terminal. 				
Figure 1 Functional Block Diagram	Ground Pin# 5 Ground Pin# 7 RF IN Pin# 8				
Figure 2 Package Outline Dimensions	Dimensions in inches TOP VIEW BOTTOM VIEW U D D D D D D D D				

Specifications are based on most current or latest revision.

RMLA3565A-58 RF Components Wideband Low Noise MMIC Amplifier PRODUCT INFORMATION Figure 3 Schematic for a Typical Test **Evaluation Board** (RMLA3565A-58-TB) Ray **RF out** RF in **RMLA3565** J2 J1 -58 С C2 C3 (OPT) Vdd GND **P1 C1** Т **P2** (Opt) Figure 4 **U1** Layout and Assembly of 0 Test Evaluation Board 0 0 0 0 BĨAŜI HI (RMLA3565A-58-TB) 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 **RF In RF Out** 0 0 0 0 **R**F^o С ÍN RF OUT **J1** J2 0 0 0 0 0 0 ö ٩<u>ـ</u> ₽ 00 0 0 0 Ο 0 0 0 0 0 C1 & C2 0 0 0 0 0 0 0 0 0 0 0 GNĎ (OPT) 0 0 0 , VI° 0 0 0 0 0 0 0 0 С ŇUŇ Ģ 18 657 **C**3 0 0 0 0 0 Ground Vdd P1 (GND) P2 **Test Procedure** The following sequence of procedure must be followed to properly test the power amplifier: for the evaluation board Step 1: Turn off RF input power. After the bias condition is Step 4: (RMLA3565A-58-TB) established, RF input signal may now be Step 2: Use GND terminal of the evaluation board applied. to connect DC supply grounds. Step 5: Follow turn-off sequence of: Step 3: Apply drain supply voltage of +4.0 V to evaluation board terminal Vdd. (i) Turn off RF input power. (ii) Turn down and off Vdd. Parts List Vendor(s) Part **EIA Size** for test evaluation board RMLA3565A-58-TB) C1 330 pF .04" x .02" AVX, Murata, Novacap, .04" x .02" C2 1000 pF AVX, Murata, Novacap 4.75 uF .14"x .11" Sprague, ATC, AVX, Murata C3 U1 RMLA3565A-58 .28" x .28" x .07" Ravtheon P1, P2 Terminal Samtec

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Raytheon RF Components 362 Lowell Street Andover, MA 01810

E.F. Johnson

Raytheon

J1, J2

Board

SMA Connectors

RO4003(Rogers)

1.99x1.50x.032



Specifications are based on most current or latest revision.

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